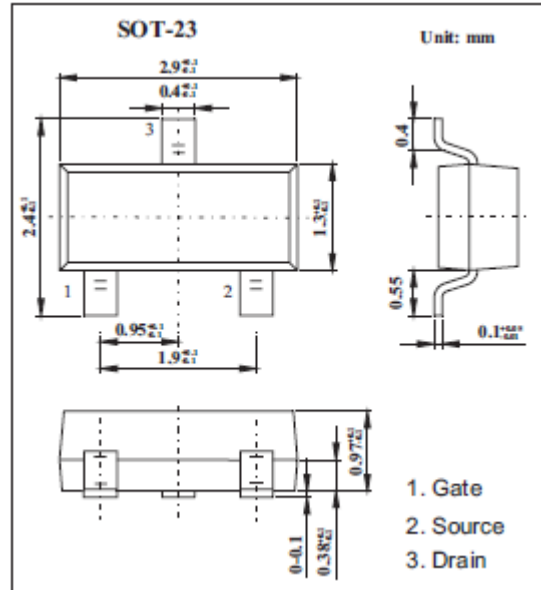
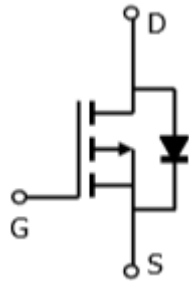


P-Channel 60-V(D-S) MOSFET

SI2309

■ Features

- ◆ TrenchFET Power MOSFET
- ◆ RoHS Compliant



■ Absolute Maximum Ratings $T_a=25^{\circ}\text{C}$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (T _J =150°C) *1,2	I _D	-1.25	A
		-0.85	
Pulsed Drain Current	I _{DM}	-8	A
Avalanche Current	I _{AS}	-5	A
	L = 0.1 mH		
Power Dissipation*1,2	P _D	1.25	W
		0.8	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Maximum Junction-to-Ambient*2	R _{thJA}	145	°C/W
Maximum Junction-to-Ambient*3		175	

*1. Pulse Width limited by maximum junction temperature.

*2. Surface Mounted on FR4 Board, $t \leq 5\text{sec}$.

*3. Surface Mounted on FR4 Board.

■ Electrical Characteristics Ta=25°C

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=-250uA	-60			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=-250uA	-1.0			
Gate-Body Leakage	IGSS	VDS=0V, VGS=±20V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=-48V, VGS=0V			-1	uA
		VDS=-48V, VGS=0V, Tj=125°C			-50	
On-State Drain Current	ID(on)	VDS≥-4.5V, VGS=-10V	-6	.	.	A
Drain-Source On-State Resistance*	RDS(on)	VGS=-10V, ID=-1.25A		0.275	0.340	Ω
		VGS=-4.5V, ID=-1A		0.406	0.550	
Forward Transconductance*	gFS	VDS=-4.5V, ID=-1A		1.9		S
Diode Forward Voltage*	VSD	Is=-1.25A, VGS=0V		-0.82	-1.2	V
Total Gate Charge*	Qg	VDS=-30V, VGS=-10V, ID=-1.25A		5.4	12	nC
Gate-Source Charge*	Qgs			1.15		
Gate-Drain Charge*	Qgd			0.92		
Input Capacitance	Ciss	VDS=-15V, VGS=0V, f=1MHz		380		pF
Output Capacitance	Coss			100		
Reverse Transfer Capacitance	Crss			75		
Turn-On Time	td(on)	VDS=-30V, RL=30Ω, ID=-1A, VGEN=-4.5V,		10.5	20	ns
	tr			11.5	20	
Turn-Off Time	Td(off)	RG=6Ω		15.5	30	ns
	Tf			7.5	15	

*Pulse Test: Pulse Width ≤300μ, Duty Cycle≤2%.